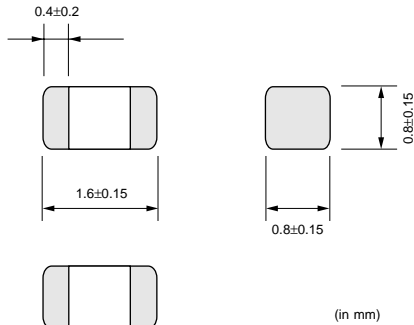


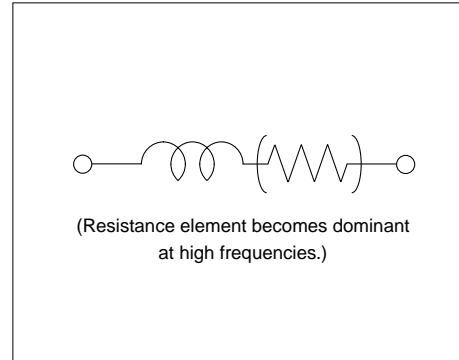
# Chip EMIFIL® Inductor Type for GHz Noise Chip Ferrite Beads

## BLM18H Series (0603 Size)

### Dimension



### Equivalent Circuit



### Packaging

Code	Packaging	Minimum Quantity
D	180mm Paper Tape	4000
J	330mm Paper Tape	10000
B	Bulk(Bag)	1000

### Rated Value (□: packaging code)

Part Number	Impedance (at 100MHz/20°C)	Impedance (at 1GHz/20°C)	Rated Current	DC Resistance(max.)	Operating Temperature Range	Number of Circuits
BLM18HG471SN1□	470ohm±25%	600ohm(Typ.)	200mA	0.85ohm	-55°C to +125°C	1
BLM18HG601SN1□	600ohm±25%	700ohm(Typ.)	200mA	1.00ohm	-55°C to +125°C	1
BLM18HG102SN1□	1000ohm±25%	1000ohm(Typ.)	100mA	1.60ohm	-55°C to +125°C	1
BLM18HB121SN1□	120ohm±25%	500ohm±40%	200mA	0.50ohm	-55°C to +125°C	1
BLM18HB221SN1□	220ohm±25%	1100ohm±40%	100mA	0.80ohm	-55°C to +125°C	1
BLM18HB331SN1□	330ohm±25%	1600ohm±40%	50mA	1.20ohm	-55°C to +125°C	1
BLM18HD471SN1□	470ohm±25%	1000ohm(Typ.)	100mA	1.20ohm	-55°C to +125°C	1
BLM18HD601SN1□	600ohm±25%	1200ohm(Typ.)	100mA	1.50ohm	-55°C to +125°C	1
BLM18HD102SN1□	1000ohm±25%	1700ohm(Typ.)	50mA	1.80ohm	-55°C to +125°C	1
BLM18HE601SN1□	600ohm±25%	600ohm(Typ.)	800mA	0.25ohm	-55°C to +125°C	1
BLM18HE102SN1□	1000ohm±25%	1000ohm(Typ.)	600mA	0.35ohm	-55°C to +125°C	1
BLM18HE152SN1□	1500ohm±25%	1500ohm(Typ.)	500mA	0.50ohm	-55°C to +125°C	1
BLM18HK331SN1□	330ohm±25%	400ohm±40%	200mA	0.50ohm	-55°C to +125°C	1
BLM18HK471SN1□	470ohm±25%	600ohm±40%	200mA	0.70ohm	-55°C to +125°C	1
BLM18HK601SN1□	600ohm±25%	700ohm±40%	100mA	0.90ohm	-55°C to +125°C	1
BLM18HK102SN1□	1000ohm±25%	1200ohm±40%	50mA	1.50ohm	-55°C to +125°C	1

Continued on the following page.

● This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

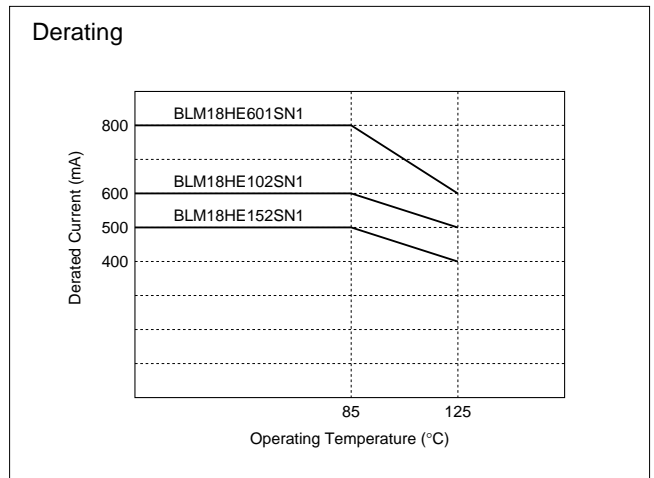
### Note:

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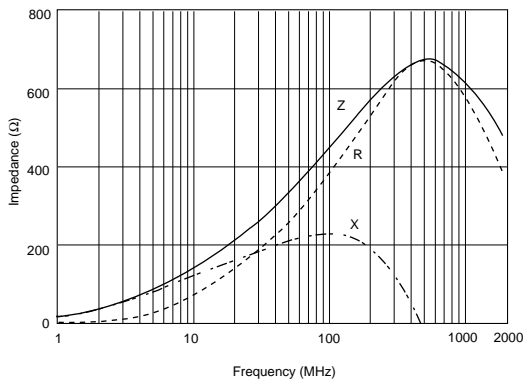
**Notice (Rating)**

In operating temperature exceeding +85°C, derating of current is necessary for BLM18HE series. Please apply the derating curve shown in chart according to the operating temperature.



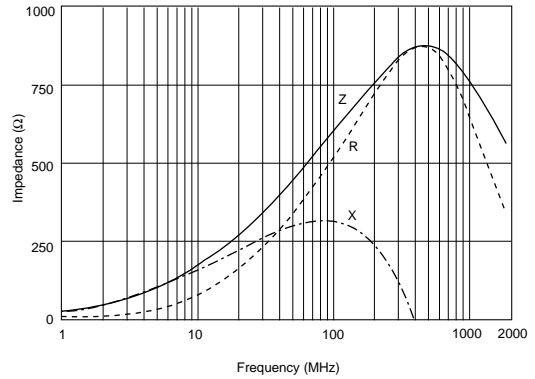
**Impedance-Frequency Characteristics**

**BLM18HG471SN1**



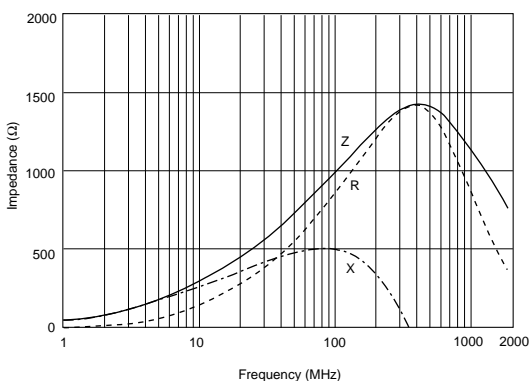
**Impedance-Frequency Characteristics**

**BLM18HG601SN1**



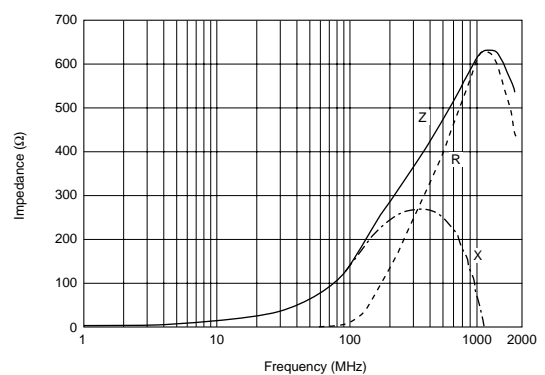
**Impedance-Frequency Characteristics**

**BLM18HG102SN1**



**Impedance-Frequency Characteristics**

**BLM18HB121SN1**



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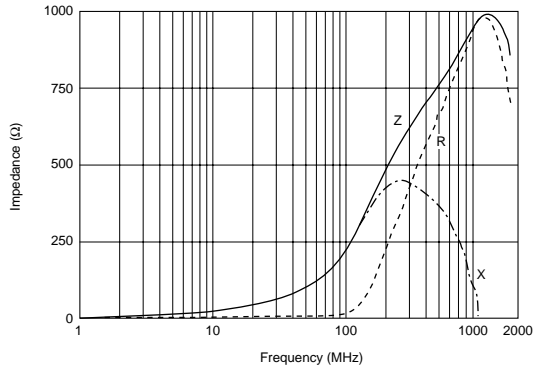
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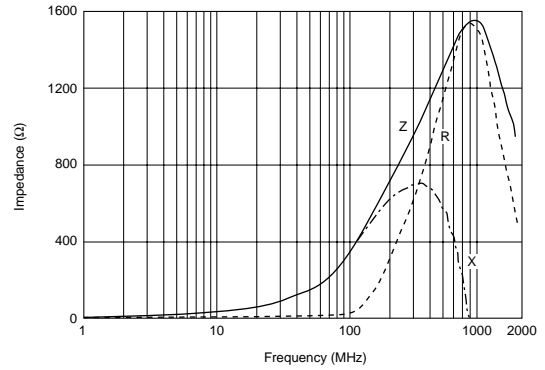
■ Impedance-Frequency Characteristics

BLM18HB221SN1



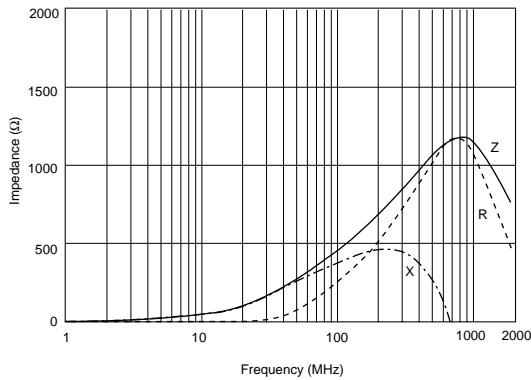
■ Impedance-Frequency Characteristics

BLM18HB331SN1



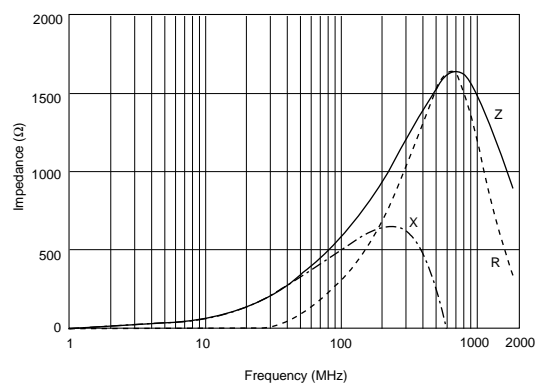
■ Impedance-Frequency Characteristics

BLM18HD471SN1



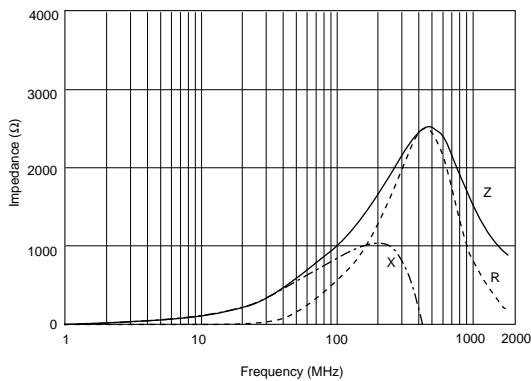
■ Impedance-Frequency Characteristics

BLM18HD601SN1



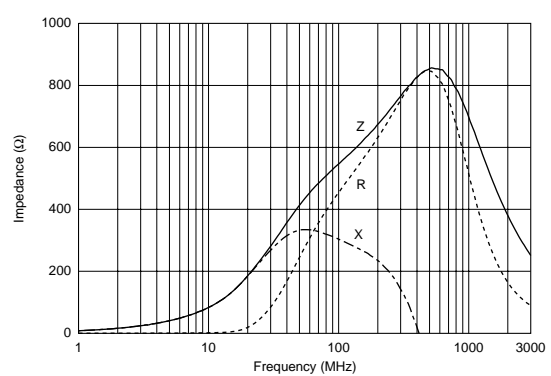
■ Impedance-Frequency Characteristics

BLM18HD102SN1



■ Impedance-Frequency Characteristics

BLM18HE601SN1



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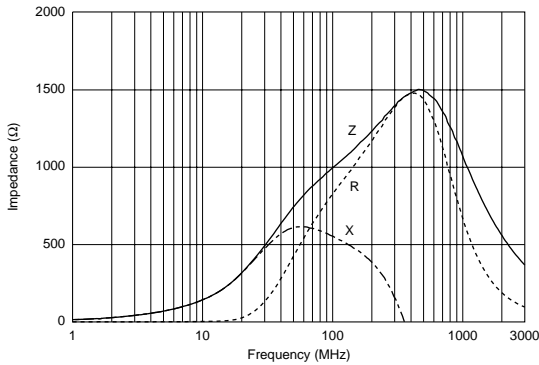
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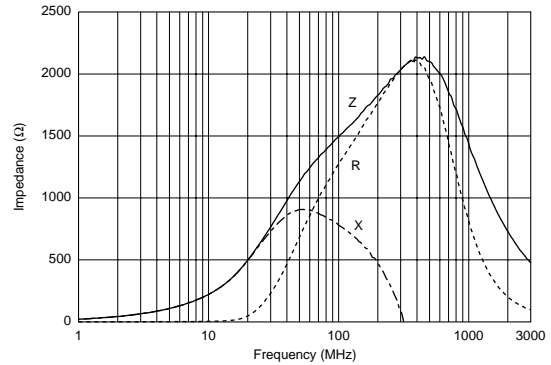
■ Impedance-Frequency Characteristics

**BLM18HE102SN1**



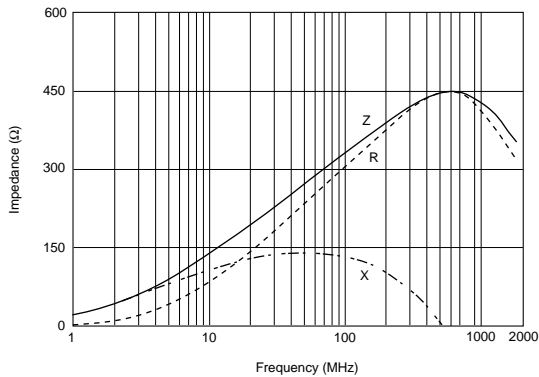
■ Impedance-Frequency Characteristics

**BLM18HE152SN1**



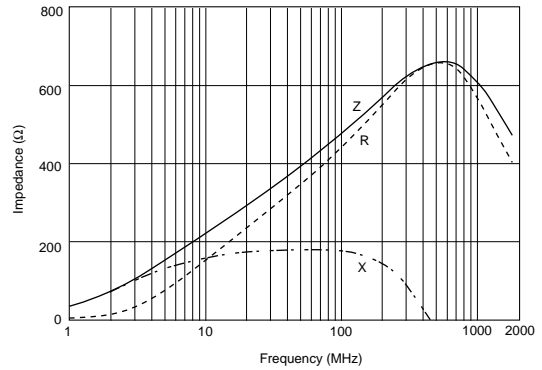
■ Impedance-Frequency Characteristics

**BLM18HK331SN1**



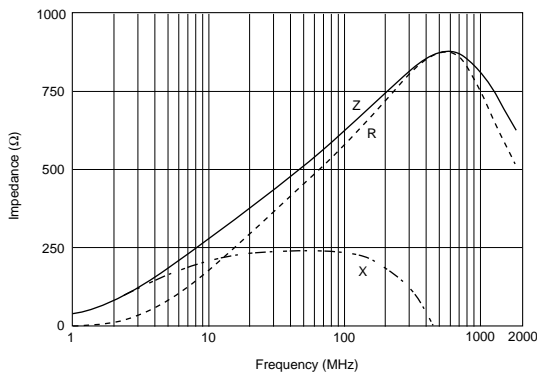
■ Impedance-Frequency Characteristics

**BLM18HK471SN1**



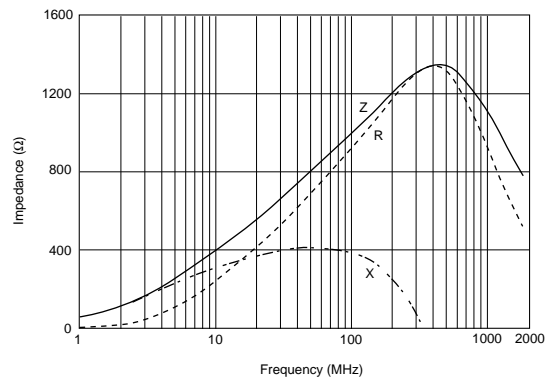
■ Impedance-Frequency Characteristics

**BLM18HK601SN1**



■ Impedance-Frequency Characteristics

**BLM18HK102SN1**




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## ■ ⚠ Caution/Notice

### ⚠ Caution (Rating)

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

### Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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